



PATENT

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Date 06/06/02 Michael Ritzdorf

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : T.L. Ritzdorf, et al.
Application No. : 09/386,734 Confirmation No.: 1735
Filed : August 31, 1999
For : METHOD AND APPARATUS FOR LOW TEMPERATURE
ANNEALING OF METALLIZATION MICRO-STRUCTURES IN
THE PRODUCTION OF A MICROELECTRONIC DEVICE

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Examiner : G. Wyszomierski
Art Unit : 1742
Docket No. : 29195.8170US
Date : 6 June 2002

Commissioner for Patents
Washington, DC 20231

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AMENDMENT

Dear Commissioner:

The present amendment is being filed in response to the Office Action mailed 20 December 2001 in the above-identified application. Please amend claims 36, 143, 153 and 156 as shown in the attached Appendix; cancel claims 38, 39, 68-70, 72, 74, 76-116, and 183-185; and add new claims 186-215. All pending claims as so amended follow.